1. Part No. Expression:

<u>WQ4420352KF10DS</u>

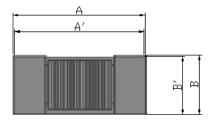
(a) (b) (c) (d) (e) (f)

- (a) Series Code
- (b) Dimension Code
- (c) Inductance Code

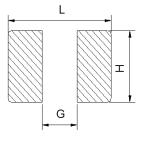
(e) Test Frequency(f) Category Code

(d) Tolerance Code

2. Configuration & Dimensions:





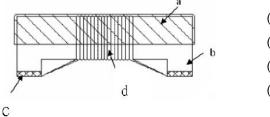


Recommended PCB layout

Unit: mm

А	A'	В	B'	С	C'	D	L	G	Н
4.55±0.25	4.2±0.2	2.2±0.25	1.8±0.2	2.0±0.2	1.8±0.2	0.98 Ref.	4.6 Ref.	2.54 Ref.	2.0 Ref.

3. Material List:



- (a) Upper Plate
- (b) Core

(c) Termination

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(d) Wire

NOTE: Specifications subject to change without notice. Please check our website for latest information.

4. General Specification:

(a) Reliability test for this part meets AEC-Q200 standard

- (b) Operating Temp. : -55°C to +125°C(Including self temperature rise)
- (c) Storage Temp. : -55°C to +125°C (on board)
- (d) Humidity Range: 85 ± 3% RH
- (e) Storage Condition (Component in its packaging)
 - Temperature: Less than 40°C i)
 - ii) Humidity : 60% RH

5. Electrical Characteristics:

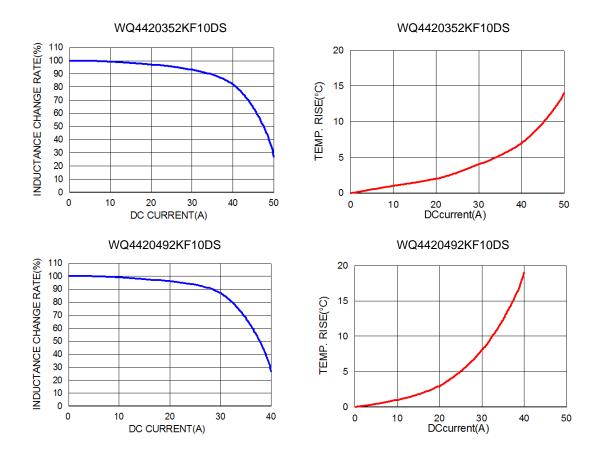
Part Number	Inductance (uH)	Test Frequency (Hz)	SRF (MHz) Min.	DCR (Ω) Max.	Rated Current (mA) Max.
WQ4420352KF10DS	3500±10%	0.1V/10K	1.00	85	20
WQ4420492KF10DS	4900±10%	0.1V/10K	0.65	109	20

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6. Characteristics Curves:



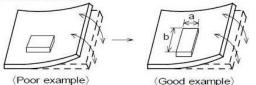
7. Soldering:

7-1. Attention regarding P.C.B. bending

The following shall be considered when designing P.C.B.'S

(a)P.C.B. shall be designed so that products are not subjected to the mechanical stress for board warpage.

<Products direction>



(b) Products location on P.C.B.

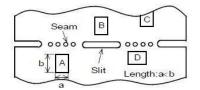
Products (A,B,C,D) shall be located carefully

to prevent mechanical stress when warping the board.

Products may be subjected to the mechanical

stress in the order of A>C>B = D.

Products shall be located in the sideways direction (Length:a<b) to against the mechanical stress.



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27/12/2017

7-2. Soldering

Mildly activated rosin fluxes are preferred. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-2.1 Solder Re-flow

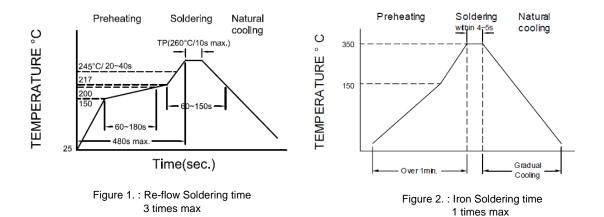
Recommended temperature profiles for re-flow soldering in Figure 1.

7-2.2 Soldering Iron (Figure 2)

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- a) Preheat circuit and products to 150°C.
- b) 355°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 sec.

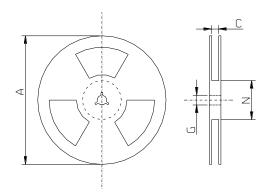


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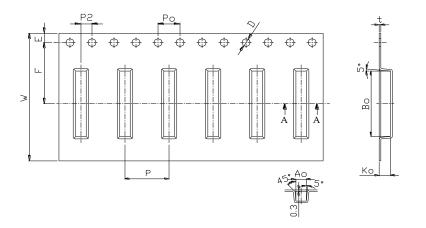
8. Packaging Information:

8-1 Reel Dimension



Type A(mm)		C(mm)	G(mm)	N(mm)	
7"x12mm	180±2.0	16.5±1.0	13.5±0.5	100±2.0	

8-2 Tape Dimension



Size	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)
3120	8.00±0.1	4.00±0.1	2.00±0.1	5.00±0.10	2.50±0.10	2.10±0.10
W/4420E	D(mm)	E(mm)	F(mm)	W(mm)	t(mm)	
W4420F	1.50+0.1/-0	1.75±0.1	5.50±0.1	12.00±0.30	0.30±0.05	

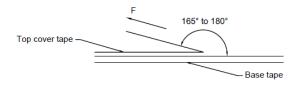
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P5

Chip Size	WQ4420-DS
Chip/Reel	1,000

8-4 Tearing Off Force



The force for tearing off cover tape is 10 to 80 grams in the
arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

Application Notice:

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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